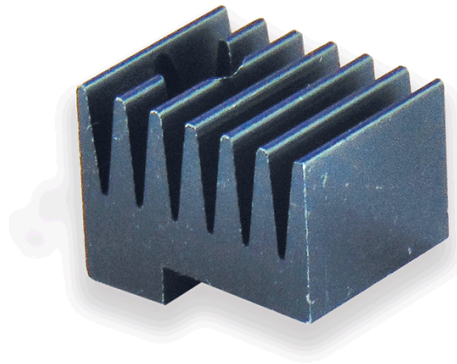


Product features AK

352/15/SE

Semiconductor casing:	TO-218 ; TOP-3
Semiconductor mounted by:	Screw
Heat sink mounted by:	Srew-On
Finish	Black Anodised
Material	AlMgSi0,5
Width [mm]:	20.0
Height [mm]:	15.0
Length [mm]:	15.0
Min. thermal resistance [K/W]:	28.0



Further information

Top-mounted and contact pressure heat sinks for optimised contact pressure and additional cooling - Reduced contact thermal resistance (R_{thGK}) to the primary heat sink and avoidance of 'hot spots' by means of ull-surface contact pressure - Reduced overall thermal resistance (R_{th}) via additional heat carry-off - R_{thK} -values obtained for „stand-alone“ - application - For individual M 2,5 / M 3 screwed assembly as standard - Special dimensions, e.g. for multiple assembly, on request - from AlMgSi 0,5 F22, black anodized - for cases TO-220

